## BSC024N025S G-VB Datasheet N-Channel 30 V (D-S) MOSFET

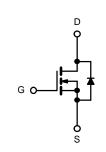
PRODUCT SUMMARY							
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a, e</sup>	Q <sub>g</sub> (Typ.)				
30	0.0018 at V <sub>GS</sub> = 10 V	160	82 nC				
	0.0025 at V <sub>GS</sub> = 4.5 V	130	02 110				

#### **FEATURES**

- Trench Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested

#### **APPLICATIONS**

- OR-ing
- Server



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	<b>S</b> (T <sub>A</sub> = 25 °C, unle	ss otherwise not	ed)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	v	
	T <sub>C</sub> = 25 °C		160 <sup>a, e</sup>		
Continuous Drain Current (T <sub>1</sub> = 175 °C)	T <sub>C</sub> = 70 °C		90 <sup>e</sup>		
Continuous Drain Current $(1_j = 175 C)$	T <sub>A</sub> = 25 °C	I <sub>D</sub>	33 <sup>b, c</sup>	А	
	T <sub>A</sub> = 70 °C		29.8 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	300		
Avalanche Current Pulse	L = 0.1 mH	I <sub>AS</sub>	36		
		Е			

Notes:

a. Based on  $T_C = 25$  °C. b. Surface mounted on 1" x 1" FR4 board. c. t = 10 s. d. Maximum under steady state conditions is 90 °C/W. e. Calculated based on maximum junction temperature. Package limitation current is 90 A.

Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit	
Static				•			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	— In = 250 UA		35		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 7.5			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.5		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Correct	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	- μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	90			А	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 32 A		0.0018			
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS}$ = 4.5 V, I <sub>D</sub> = 29 A		0.0025		Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 32 \text{ A}$		160		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>				9900	pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = 12.5 V, $V_{GS}$ = 0 V, f = 1 MHz			1725		
Reverse Transfer Capacitance	C <sub>rss</sub>				970		
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 32 \text{ A}$			83		
Total Gate Charge	∝g				82		
ate-Source Charge Q <sub>gs</sub>		$V_{DS}$ = 15 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 29 A			34	ne	
Gate-Drain Charge	Q <sub>gd</sub>				29	]	
Gate Resistance	Rg	f = 1 MHz		1.4	2.1	Ω	
Turn-On Delay Time	irn-On Delay Time t <sub>d(on)</sub>			18	27		
Rise Time	t <sub>r</sub>	$\begin{array}{l} V_{DD}=15\;V,R_{L}=0.555\;\Omega\\ I_{D}\cong27\;A,V_{GEN}=10\;V,R_{g}=1\;\Omega \end{array}$		11	17	- - - -	
Turn-Off Delay Time	t <sub>d(off)</sub>			70	105		
Fall Time	t <sub>f</sub>			10	15		
Turn-On Delay Time	t <sub>d(on)</sub>			55	83		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 0.625 $\Omega$		180	270		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 24 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		55	83		
Fall Time	t <sub>f</sub>			12	18		
Drain-Source Body Diode Characteristics	5						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	$T_{C} = 25 \ ^{\circ}C$			100	A	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				200		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 22 A		0.8	1.2	V	
Body Diode Reverse Recovery Time t <sub>rr</sub>				52	78	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 20 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C		70.2	105	nC	
Reverse Recovery Fall Time	t <sub>a</sub>			27		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			25			

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

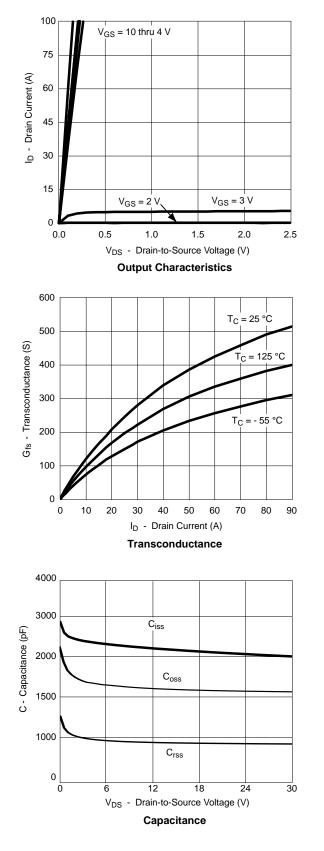
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

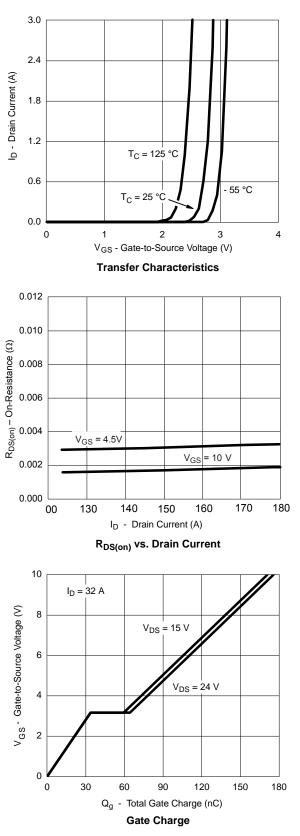
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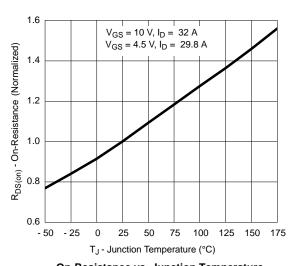


## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

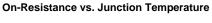


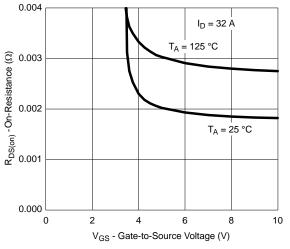




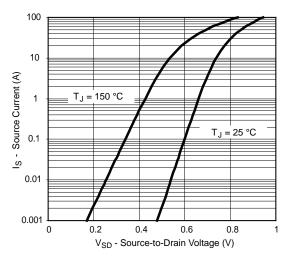


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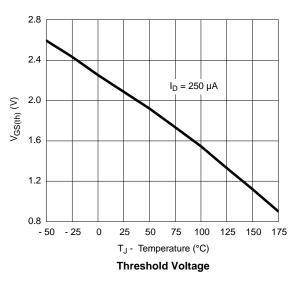


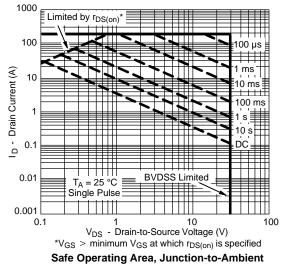


 $R_{DS(on)}$  vs.  $V_{GS}$  vs. Temperature

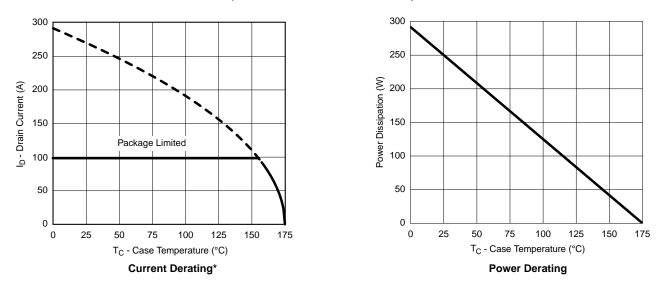


Forward Diode Voltage vs. Temperature



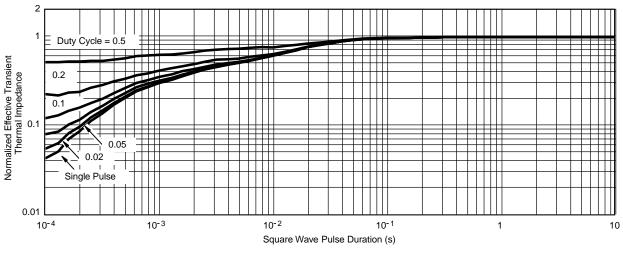




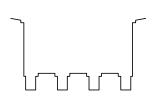


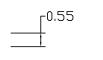
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\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Case





3.625

E2

0.14.



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